

Is Now Part of



## **ON Semiconductor**®

# To learn more about ON Semiconductor, please visit our website at <u>www.onsemi.com</u>

Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (\_), the underscore (\_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (\_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at <a href="mailto:www.onsemi.com">www.onsemi.com</a>. Please email any questions regarding the system integration to <a href="mailto:Fairchild\_questions@onsemi.com">Fairchild\_questions@onsemi.com</a>.

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or unavteries, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out or i, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor and is officers, employees, uniotificated use, even if such claim any manner.



### N-Channel Shielded Gate PowerTrench<sup>®</sup> MOSFET **100 V, 78 A, 7.2 m**Ω

#### Features

- Shielded Gate MOSFET Technology
- Max  $r_{DS(on)} = 7.2 \text{ m}\Omega \text{ at } V_{GS} = 10 \text{ V}, I_D = 28 \text{ A}$
- Max r<sub>DS(on)</sub> = 19.5 mΩ at V<sub>GS</sub> = 6 V, I<sub>D</sub> = 14 A
- 50% Lower Qrr than Other MOSFET Suppliers
- Lowers Switching Noise/EMI
- MSL1 Robust Package Design
- 100% UIL Tested
- RoHS Compliant

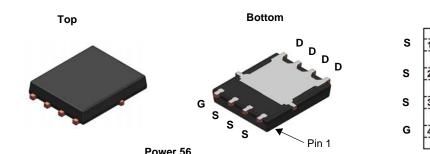


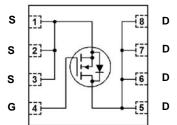
#### **General Description**

This N-Channel MV MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench® process that incorporates Shielded Gate technology. This process has been optimized to minimize on-state resistance and yet maintain superior switching performance with best in class soft body diode.

#### Applications

- Primary DC-DC MOSFET
- Synchronous Rectifier in DC-DC and AC-DC
- Motor Drive
- Solar





Power 56

#### **MOSFET Maximum Ratings** T<sub>A</sub> = 25 °C unless otherwise noted.

Symbol	Parameter			Ratings	Units	
V <sub>DS</sub>	Drain to Source Voltage			100	V	
V <sub>GS</sub>	Gate to Source Voltage			±20	V	
ID	Drain Current -Continuous	T <sub>C</sub> = 25 °C	(Note 5)	78		
	-Continuous	T <sub>C</sub> = 100 °C	(Note 5)	49	^	
	-Continuous	T <sub>A</sub> = 25 °C	(Note 1a)	13	Α	
	-Pulsed		(Note 4)	364		
E <sub>AS</sub>	Single Pulse Avalanche Energy		(Note 3)	216	mJ	
P <sub>D</sub>	Power Dissipation	T <sub>C</sub> = 25 °C		83		
	Power Dissipation	T <sub>A</sub> = 25 °C	(Note 1a)	2.5		
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range			-55 to +150	°C	

#### **Thermal Characteristics**

$R_{\thetaJC}$	Thermal Resistance, Junction to Case	1.5	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient (Note 1a)	50	C/VV

#### **Package Marking and Ordering Information**

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS86182	FDMS86182	Power 56	13 "	12 mm	3000 units

September

2016

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
Off Chara	cteristics					
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$I_{D} = 250 \ \mu A, \ V_{GS} = 0 \ V$	100			V
$\Delta BV_{DSS} \Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$ , referenced to 25 °C		56		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 80 V, V <sub>GS</sub> = 0 V			1	μA
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V},  V_{DS} = 0 \text{ V}$			100	nA
On Chara	cteristics					
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 150 μA	2.0	3.2	4.0	V
$\Delta V_{GS(th)} \Delta T_J$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 150 \ \mu\text{A}$ , referenced to 25 °C		-9		mV/°C
r <sub>DS(on)</sub>	Static Drain to Source On Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 28 A		5.9	7.2	
		V <sub>GS</sub> = 6 V, I <sub>D</sub> = 14 A		9.3	19.5	mΩ
		$V_{GS}$ = 10 V, $I_{D}$ = 28 A, $T_{J}$ = 125 °C		9.9	12.1	
9 <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = 5 V, I <sub>D</sub> = 28 A		63		S
-	Characteristics					
C <sub>iss</sub>	Input Capacitance			1880	2635	pF
C <sub>oss</sub>	Output Capacitance	─ V <sub>DS</sub> = 50 V, V <sub>GS</sub> = 0 V, f = 1 MHz		1105	1550	pF
C <sub>rss</sub>	Reverse Transfer Capacitance			13	25	pF
R <sub>g</sub>	Gate Resistance		0.1	0.5	1.2	Ω
Switching	g Characteristics					
t <sub>d(on)</sub>	Turn-On Delay Time			13	24	ns
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 50 V, I <sub>D</sub> = 28 A,		4	10	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		18	33	ns
t <sub>f</sub>	Fall Time			4	10	ns
Qg	Total Gate Charge	V <sub>GS</sub> = 0 V to 10 V		26	37	nC
Q <sub>g</sub>	Total Gate Charge	$V_{GS} = 0 \text{ V to } 6 \text{ V}$ $V_{DD} = 50 \text{ V},$		17	24	nC
Q <sub>gs</sub>	Gate to Source Charge	I <sub>D</sub> = 28 A		8.2		nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge			5.1		nC
Q <sub>oss</sub>	Output Charge	$V_{DD} = 50 \text{ V}, V_{GS} = 0 \text{ V}$		73		nC
Drain-Sou	urce Diode Characteristics					
V <sub>SD</sub>	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 2.1 A$ (Note 2)		0.7	1.2	- V
		V <sub>GS</sub> = 0 V, I <sub>S</sub> = 28 A (Note 2)		0.8	1.3	
t <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> = 14 A, di/dt = 300 A/μs		28	45	ns
Q <sub>rr</sub>	Reverse Recovery Charge	$F = 14 \Lambda$ , $u/u = 300 \Lambda/\mu$		52	84	nC
t <sub>rr</sub>	Reverse Recovery Time	— I <sub>F</sub> = 14 A, di/dt = 1000 A/μs		22	36	ns
Qrr	Reverse Recovery Charge	$r_{\rm F} = 1 + 7.$ , u/u = 1000 7/µ3		116	186	nC

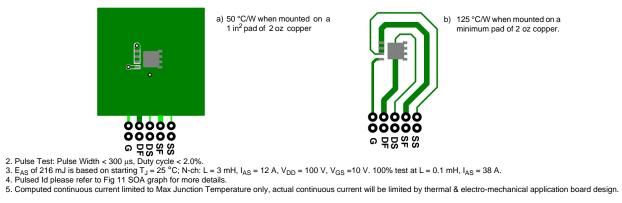
Q<sub>rr</sub> Notes:

©2016 Fairchild Semiconductor Corporation

FDMS86182 Rev. 1.0

1. R<sub>0JA</sub> is determined with the device mounted on a 1 in<sup>2</sup> pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R<sub>0CA</sub> is determined by the user's board design.

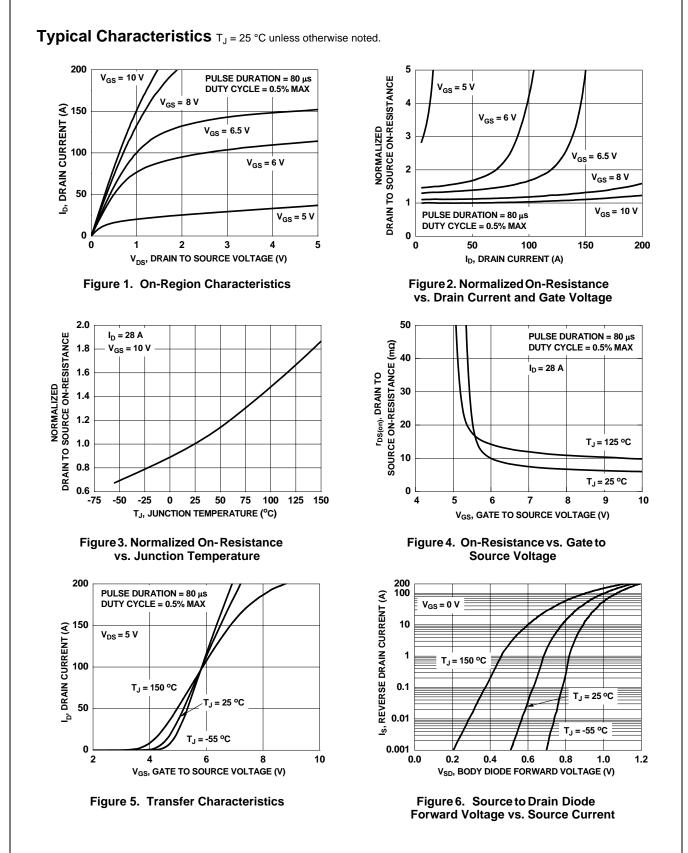
a) 50 °C/W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper

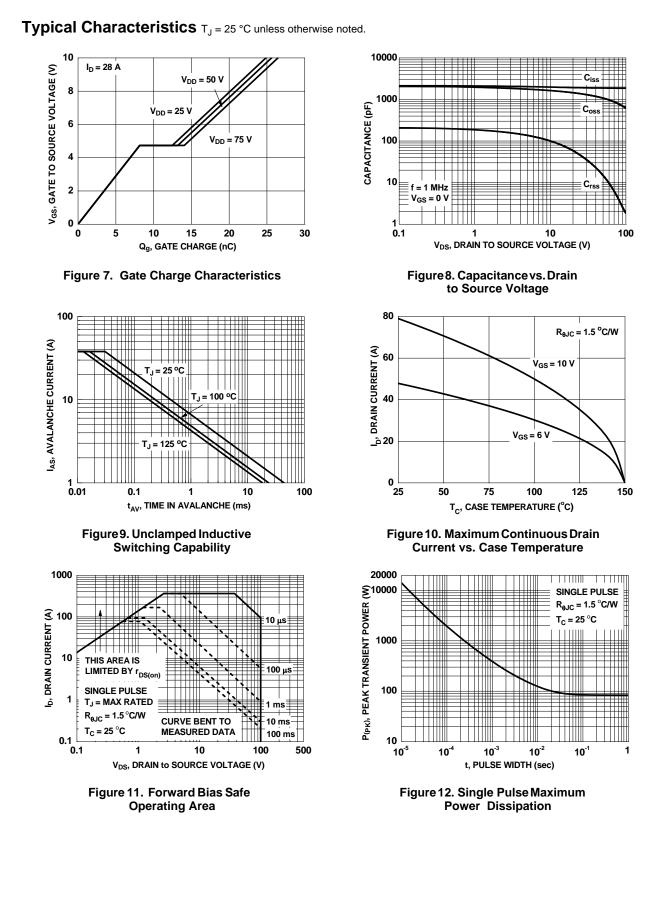


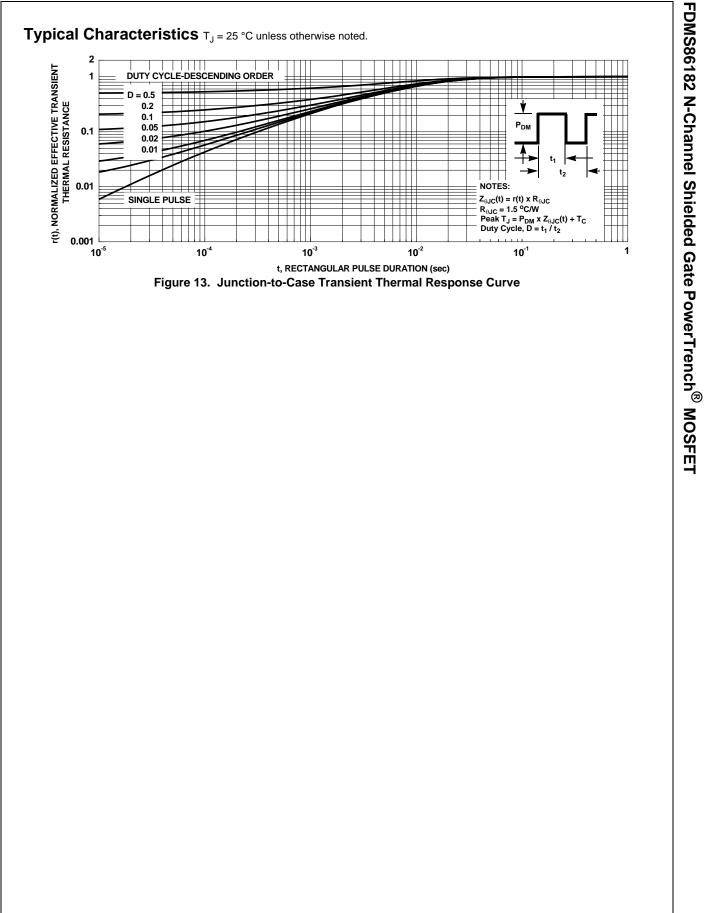
Reverse Recovery Charge



b) 125 °C/W when mounted on a minimum pad of 2 oz copper.









ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor haves against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death a

#### PUBLICATION ORDERING INFORMATION

#### LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910

Japan Customer Focus Center Phone: 81-3-5817-1050 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

© Semiconductor Components Industries, LLC